Final datasheet
CoolSiC™ Schottky diode 2000 V G5

Features

- V_{RRM} = 2000 V
- I_F = 50 A
- V_F = 1.5 V
- No reverse recovery current / no forward recovery
- High surge current capability
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Specified dv/dt ruggedness
- .XT interconnection technology for best-in-class thermal performance

Lead-free
Green
Halogen-free
RoHS

Potential applications

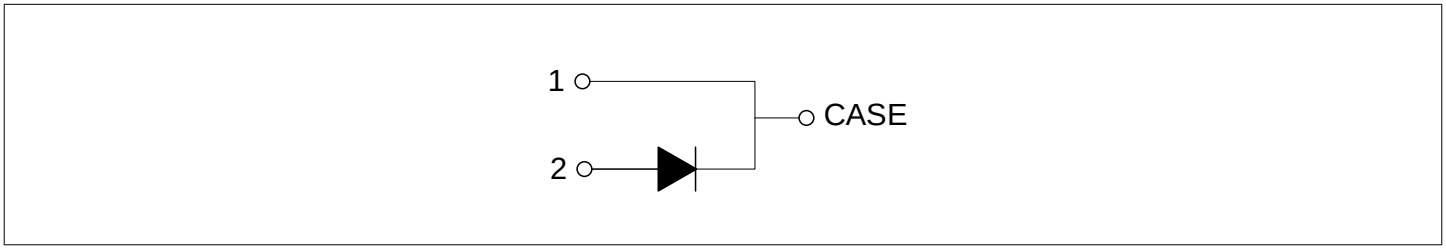
- String 3-phase inverter
- EV Charging

Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Description

Pin definition:
Pin 1 – Cathode
Pin 2 – Anode



Type	Package	Marking
IDWD50G200C5	PG-TO247-2-U01	D5020C5

Table of contents

1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	M	M3 screw, Maximum of mounting processes: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				62	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$			0.15	0.19	K/W

2 SiC Diode

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} \geq 25$ °C		2000	V
Continuous forward current for $R_{th(j-c,max)}$	I_F	$D = 1$	$T_c = 25$ °C	140	A
			$T_c = 135$ °C	67	
			$T_c = 151$ °C	50	
Surge repetitive forward current, sine halfwave[1)]	$I_{F,RM}$	$t_p = 10$ ms	$T_c = 25$ °C	200	A
			$T_c = 100$ °C	150	
Surge non-repetitive forward current, sine halfwave	$I_{F,SM}$	$t_p = 10$ ms	$T_c = 25$ °C	325	A
			$T_c = 150$ °C	287	
Non-repetitive peak forward current	$I_{F,max}$	$T_c = 25$ °C, $t_p = 10$ µs		1900	A
I^2t value	$\int I^2t$	$t_p = 10$ ms	$T_c = 25$ °C	528	A^2s
			$T_c = 150$ °C	412	
Diode dv/dt ruggedness	dv/dt	$V_R = 0...1500$ V		100	V/ns
Power dissipation for $R_{th(j-c,max)}$	P_{tot}		$T_c = 25$ °C	789	W

1) Not subject to production test. The test was performed with 20k pulses (half-wave rectified sine with 10 ms period).

Table 3 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
DC blocking voltage	V_{DC}	T_{vj} = 25 °C		2000			V
Diode forward voltage	V_F	I_F = 50 A	T_{vj} = 25 °C		1.5	1.75	V
			T_{vj} = 150 °C		2.3		
Reverse current	I_R	V_R = 2000 V	T_{vj} = 25 °C		25	750	µA
			T_{vj} = 150 °C		180		
Total capacitive charge	Q_C	V_R = 1500 V, T_{vj} = 25 °C & 150 °C, $Q_C = \int_0^{V_R} C(V)dV$			450		nC
Total capacitance	C	f = 100 kHz	V_R = 1 V		5700		pF
			V_R = 600 V		230		
			V_R = 1500 V		155		
Operating junction temperature	T_{vj}			-55		175	°C

***Note**: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.*

Electrical Characteristic at T_{vj} = 25°C, unless otherwise specified.

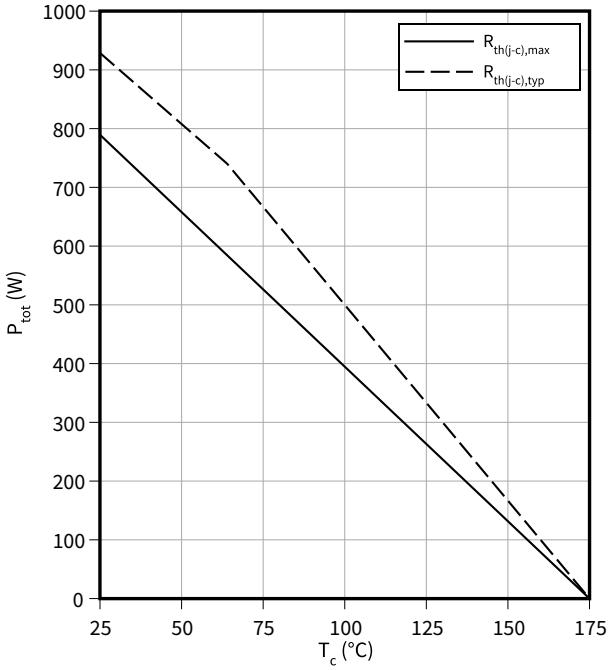
3 Characteristics diagrams

Power dissipation as function of case temperature

$P_{tot} = f(T_c)$

$T_{vj} \leq 175$ °C

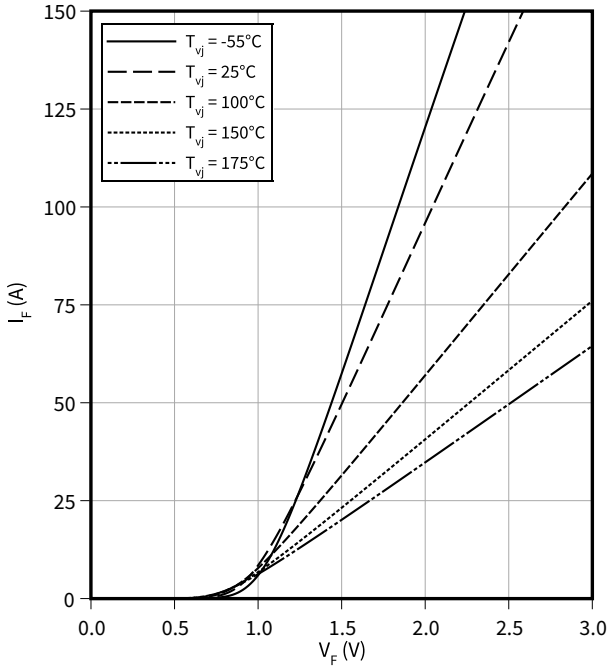
limited by bondwire



Typical forward characteristics

$I_F = f(V_F)$

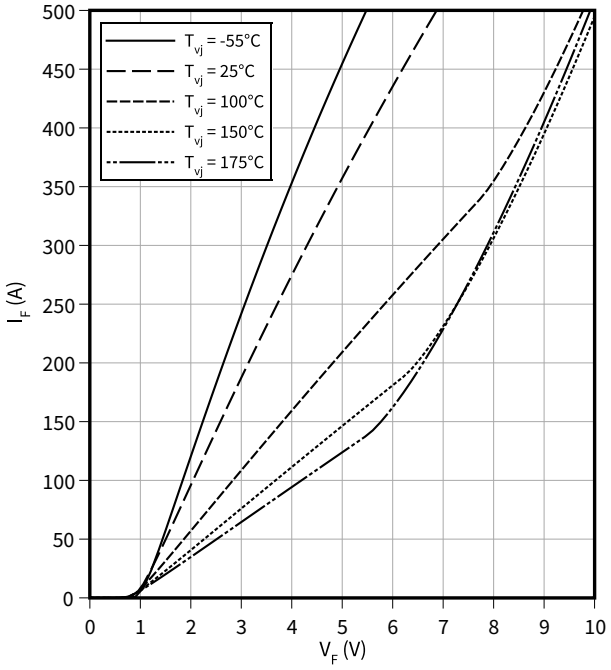
$t_p = 50$ µs



Typical forward characteristics in surge current

$I_F = f(V_F)$

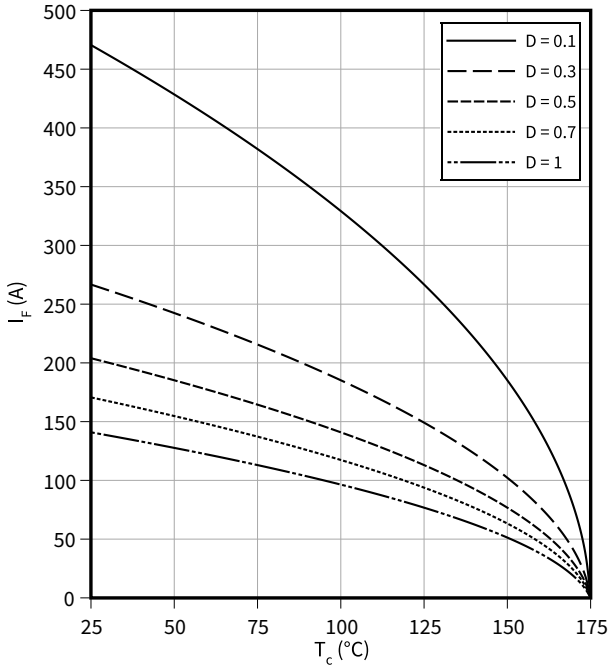
$t_p = 50$ µs



Diode forward current as function of case temperature

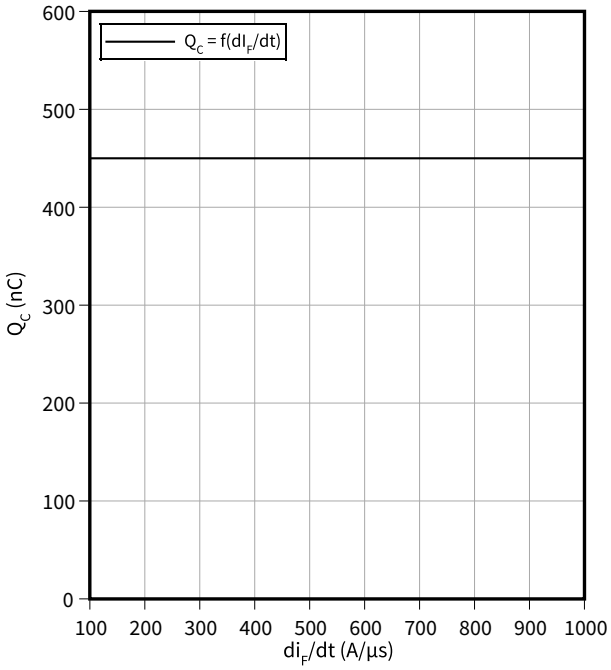
$I_F = f(T_c)$

D = duty cycle , $T_{vj} \leq 175$ °C



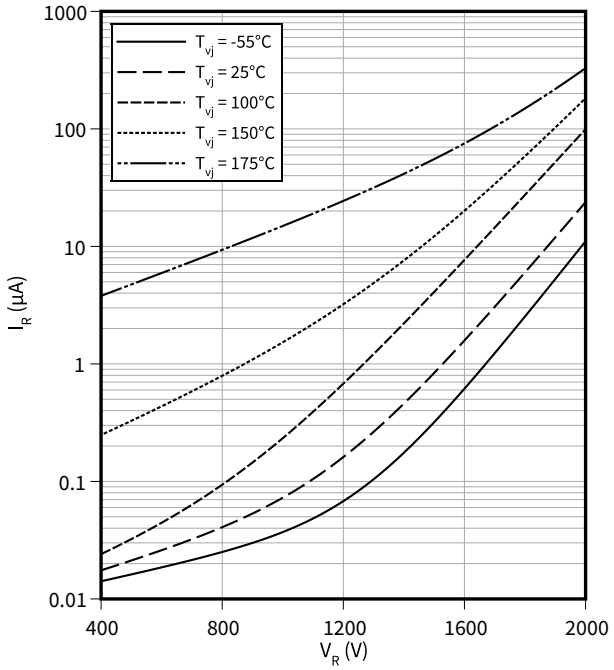
Typical capacitive charge as function of current slope

$Q_C = f(di_F/dt)$
T_{vj} = 25 °C, V_R = 1500 V
guaranteed by design



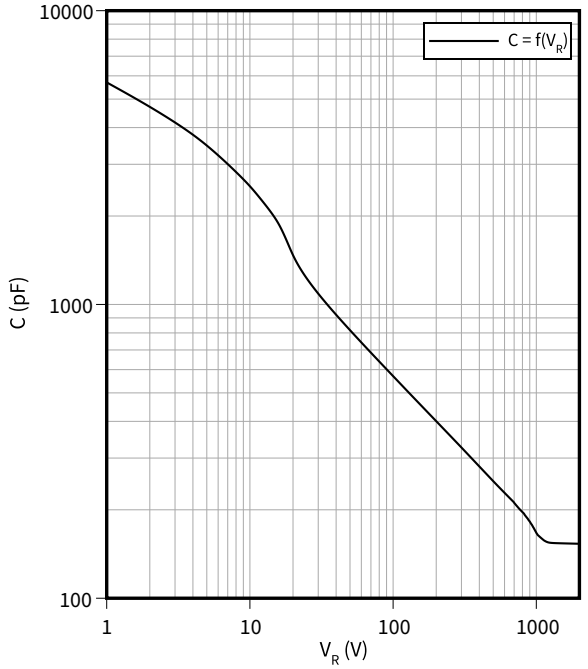
Typical reverse characteristics

$I_R = f(V_R)$



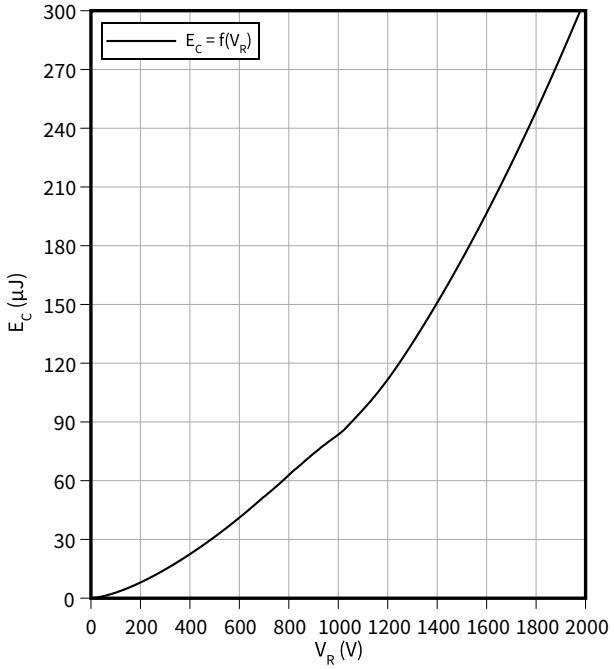
Typical capacitance as function of reverse voltage

$C = f(V_R)$
T_{vj} = 25 °C, f = 100 kHz



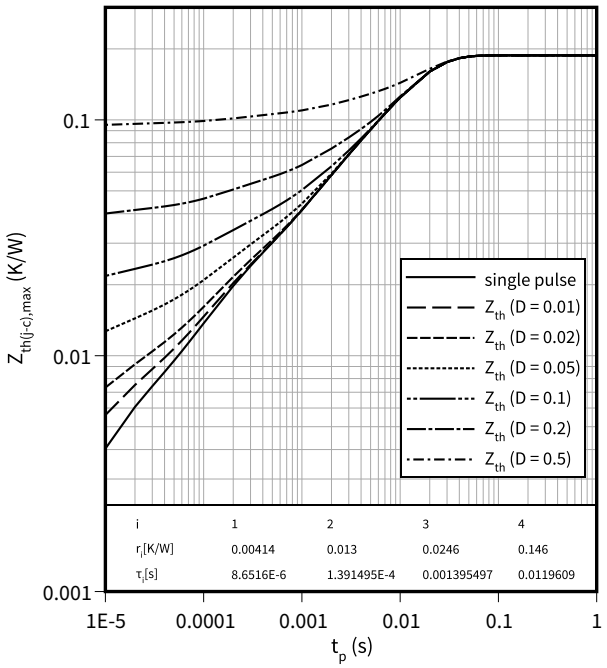
Typical capacitively stored energy as function of reverse voltage

$E_C = f(V_R)$
f = 100 kHz



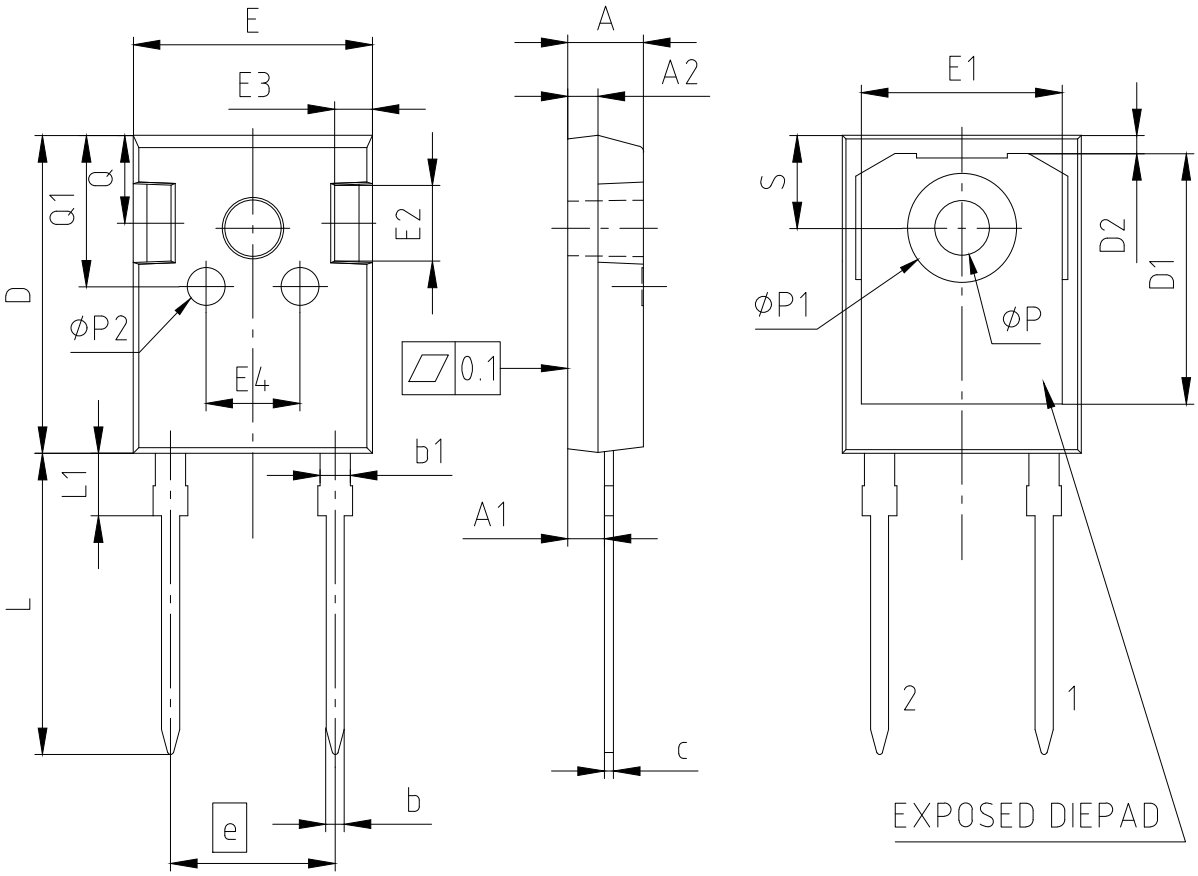
Max. transient thermal impedance

$Z_{th(j-c),max} = f(t_p)$
$D = t_p/T$



i	1	2	3	4
r_i[K/W]	0.00414	0.013	0.0246	0.146
τ_i[s]	8.6516E-6	1.391495E-4	0.001395497	0.0119609

4 Package outlines



PACKAGE - GROUP NUMBER:	PG-TO247-2-U01	
DIMENSIONS	**MILLIMETERS**	
	MIN.	MAX.
A	4.90	5.10
A1	2.31	2.51
A2	1.90	2.10
b	1.16	1.26
b1	1.96	2.06
c	0.59	0.66
D	20.90	21.10
D1	16.25	16.85
D2	1.05	1.35
E	15.70	15.90
E1	13.10	13.50
E2	4.90	5.10
E3	2.40	2.60
E4	6.00	6.40
e	10.88	
N	2	

L	19.80	20.10
L1	---	4.30
øP	3.50	3.70
øP1	7.00	7.40
øP2	2.40	2.60
Q	5.60	6.00
Q1	9.80	10.20
S	6.05	6.25

ALL DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

Figure 1

Revision history

Document revision	Date of release	Description of changes
0.10	2023-05-16	Target datasheet
0.20	2024-03-21	Preliminary datasheet
1.00	2024-09-30	Final datasheet

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